



# Search Report

## EIC 1700

STIC Database Tracking Number: 248201

To: CATHY LAM  
Location: REM-5E81  
Art Unit: 1794  
Tuesday, January 15, 2008

Case Serial Number: 10/829479

From: KENDRA BANKS  
Location: EIC1700  
REM-4B28 / REM-4A28  
Phone: (571)272-2516

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### Search Notes

Examiner LAM:

No Cases Reported

US 6,376,049



PATNO IS 6376049

DATE: JANUARY 15, 2008  
LIBRARY: PATENT  
FILE: ALL

Your search request is:  
PATNO IS 6376049

Number of PATENTS found with your search request through:  
LEVEL 1... 1

Your search request has found 1 PATENT through Level 1.  
To DISPLAY this PATENT press either the KWIC, FULL, CITE or SEGMENTS key.  
To MODIFY your search request, press the M key (for MODIFY) and then the ENTER key.

For further explanation, press the H key (for HELP) and then the ENTER key.

LEVEL 1 - 1 PATENT

1. 6376049 , April 23, 2002 , Multilayer printed wiring board and its manufacturing method, and resin composition for filling through-hole, Asai, Motoo - Ibi-gun, Japan (JP); Shimada, Kenichi - Ibi-gun, Japan (JP); Noda, Kouta - Ibi-gun, Japan (JP); Kariya, Takashi - Ibi-gun, Japan (JP); Segawa, Hiroshi - Ibi-gun, Japan (JP), 341689 (09), July 23, 1999 - ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS)., IBIDEN CO., LTD. 1, KANDA-CHO 2-CHOME OGAKI-SHI, Gifu 503-0917, (1), Reel and Frame Number: 010176/0334, Ibidem Co., Ltd., Gifu, Japan (JP), Foreign company or corporation (03)

CORE TERMS: layer, resin, conductor, through-hole, substrate, filler, particle, wiring, copper, plating ....

LEVEL 1 - 1 OF 1 PATENT

UNITED STATES PATENT AND TRADEMARK OFFICE GRANTED PATENT

6376049

April 23, 2002

Multilayer printed wiring board and its manufacturing  
method, and resin composition for filling through-hole

REISSUE: April 22, 2004 - Reissue Application filed Ex. Gp.: 1775; Re. S.N.  
10/829,479 (O.G. September 28, 2004)

CERT-CORRECTION: March 18, 2003 - a Certificate of Correction was issued for  
this patent (O.G. April 8, 2003)

APPL-NO: 341689 (09)

FILED-DATE: July 23, 1999

GRANTED-DATE: April 23, 2002

CORE TERMS: layer, resin, conductor, through-hole, substrate, filler, particle,  
wiring, copper, plating ...

6376049 OR 6,376,049

Your search request has found no ITEMS.

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6376049 OR 6,376,049

Your search request has found no CASES.

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